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Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>				Complete if Known	
				Application Number	10/763.859
				Filing Date	01/23/2004
				First Named Inventor	TAE HEON LEE
				Art Unit	2811
				Examiner Name	Unknown
				Attorney Docket Number	AMKOR-053G
Sheet	1	of	1		

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FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No.1	Foreign Patent Document Country Code 3 - Number4 - Kind Code5 (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T
pc		100220154	06/18/1999	KOREA		
		10256240	09/25/1998	JAPAN		
		10199934	07/31/1998	JAPAN		
		10163401	06/19/1998	JAPAN		
		EP0844665	05/27/1998	EU PAT. OFFICE		
		10022447	JAN-98	JAPAN		
		9293822	11/11/1997	JAPAN		
		9772358	11/07/1997	KOREA		
		EP0794572A2	10/09/1997	EU PAT. OFFICE		
pc		DE19734794A1	08/11/1997	GERMANY		

Examiner Signature	PHAT X. CAO	Date Considered	6/7/05
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PTO/SB/08A (10-01)

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Examiner Initials*	Cite No.1	Foreign Patent Document		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁶
		Country Code 3	Number ⁴ -Kind Code ⁵ (if known)				
PC			992775	04/04/1997	JAPAN		
			98205	01/10/1997	JAPAN		
			98206	01/10/1997	JAPAN		
			98207	01/10/1997	JAPAN		
			8306853	11/22/1996	JAPAN		
			8222682	08/30/1996	JAPAN		
			8125066	05/17/1996	JAPAN		
			8083877	03/26/1996	JAPAN		
			864634	03/08/1996	JAPAN		
PC			EP0720225	03/07/1996	EU PAT. OFFICE		

Examiner Signature <u>PHAT X. CAO</u>	Date Considered <u>6/7/05</u>
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Sheet	1	of	1		

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		Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)				
PC		EP0720234	03/07/1996	EU PAT. OFFICE		
		7312405	11/28/1995	JAPAN		
		7297344	11/1995	JAPAN		
		6260532	09/16/1994	JAPAN		
		6140563	05/20/1994	JAPAN		
		692076	04/05/1994	JAPAN		
		941979	01/03/1994	KOREA		
		5283460	10/29/1993	JAPAN		
		5166992	07/1993	JAPAN		
PC		5129473	05/25/1993	JAPAN		

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		Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)				
pc		4098864	09-1992	JAPAN		
I		EP0459493	12/04/1991	EU PAT. OFFICE		
		3177060	08/01/1991	JAPAN		
		EP0393997	10/24/1990	EU PAT. OFFICE		
		1251747	10/06/1989	JAPAN		
		1205544	08/1989	JAPAN		
		1175250	07/11/1989	JAPAN		
		1106456	04/24/1989	JAPAN		
pc		64054749	03/02/1989	JAPAN		
		63316470	12/23/1988	JAPAN		

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PC		63249345	10/17/1988	JAPAN		
		63233555	09/29/1988	JAPAN		
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		63067762	03/26/1988	JAPAN		
		629639	01/17/1987	JAPAN		
		6139555	02/25/1986	JAPAN		
		60231349	11/16/1985	JAPAN		
		60195957	10/04/1985	JAPAN		
		60116239	08/06/1985	JAPAN		
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PC			59227143	12/20/1984	JAPAN		
I			59208756	11/27/1984	JAPAN		
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I			5745959	03/16/1982	JAPAN		
			55163868	12/20/1980	JAPAN		
PC			EP5421117	06/08/1979	EU PAT. OFFICE		

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PC		369248	07/09/1991	JAPAN		
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Electronic Version v18

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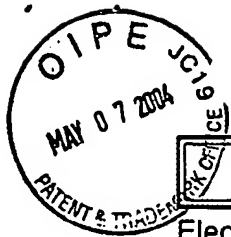
Title of Invention	SEMICONDUCTOR PACKAGE HAVING REDUCED THICKNESS																																																																																										
<p>Application Number: 10/763859</p> <p>Confirmation Number: 8528</p> <p>First Named Applicant: TAE LEE</p> <p>Attorney Docket Number: AMKOR053G</p> <p>Art Unit: 2811</p> <p>Search string: (5886398 or 5894108 or 5897339 or 5900676 or 5903049 or 5903050 or 5909053 or 5915998 or 5917242 or 5939779 or 5942794 or 5951305 or 5959356 or 5969426 or 5973388 or 5976912 or 5977613 or 5977615 or 5977630 or 5981314 or 5986333 or 5986885 or 6001671 or 6013947 or 6018189 or 6020625 or 6025640 or 6031279 or 6034423 or RE36613 or 6040626 or 6043430 or 6060768 or 6060769 or 6072228 or 6075284 or 6081029 or 6084310 or 6087715 or 6087722 or 6100594 or 6114752 or 6113474 or 6118174 or 6118184 or 6130115 or 6130473 or RE36907 or 6133623 or 6140154).pn.</p> <p>US Patent Documents</p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td>PC</td><td>1</td><td>5886398</td><td>1999-03-23</td><td>Low et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>5894108</td><td>1999-04-13</td><td>Mostafazadeh et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>3</td><td>5897339</td><td>1999-04-27</td><td>Song et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>4</td><td>5900676</td><td>1999-05-04</td><td>Kweon et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>5</td><td>5903049</td><td>1999-05-11</td><td>Mori</td><td></td><td></td><td></td></tr><tr><td></td><td>6</td><td>5903050</td><td>1999-05-11</td><td>Thurairajaratnam et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>7</td><td>5909053</td><td>1999-06-01</td><td>Fukase et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>8</td><td>5915998</td><td>1999-06-29</td><td>Stidham et al.</td><td></td><td></td><td></td></tr><tr><td>PC</td><td>9</td><td>5917242</td><td>1999-06-29</td><td>Ball</td><td></td><td></td><td></td></tr><tr><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></tr></tbody></table>				init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	PC	1	5886398	1999-03-23	Low et al.					2	5894108	1999-04-13	Mostafazadeh et al.					3	5897339	1999-04-27	Song et al.					4	5900676	1999-05-04	Kweon et al.					5	5903049	1999-05-11	Mori					6	5903050	1999-05-11	Thurairajaratnam et al.					7	5909053	1999-06-01	Fukase et al.					8	5915998	1999-06-29	Stidham et al.				PC	9	5917242	1999-06-29	Ball											
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PC	10	5939779	1999-08-17	Kim
	11	5942794	1999-08-24	Okumura et al.
	12	5951305	1999-09-14	Haba
	13	5959356	1999-09-28	Oh
	14	5969426	1999-10-19	Baba et al.
	15	5973388	1999-10-26	Chew et al.
	16	5976912	1999-11-02	Fukutomi et al.
	17	5977613	1999-11-02	Takata et al.
	18	5977615	1999-11-02	Yamaguchi et al.
	19	5977630	1999-11-02	Woodworth et al.
	20	5981314	1999-11-09	Glenn et al.
	21	5986333	1999-11-16	Nakamura
	22	5986885	1999-11-16	Wyland
	23	6001671	1999-12-14	Fjelstad
	24	6013947	2000-01-11	Lim
	25	6018189	2000-01-25	Mizuno
	26	6020625	2000-02-01	Qin et al.
	27	6025640	2000-02-15	Yagi et al.
	28	6031279	2000-02-29	Lenz
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	30	RE36613	2000-03-14	Ball
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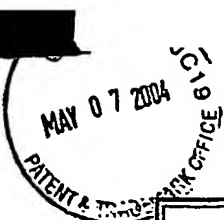
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Examiner Name	Date
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Title of Invention	SEMICONDUCTOR PACKAGE HAVING REDUCED THICKNESS																																																																																				
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Title of
Invention

SEMICONDUCTOR PACKAGE HAVING REDUCED
THICKNESS

Application Number: 10/763859



Confirmation Number: 8528

First Named Applicant: TAE LEE

Attorney Docket Number: AMKOR053G

Art Unit: 2811

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	42	6316822	2001-11-13	Venkateshwaran et al.
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<p>Application Number: 10/763859</p> <p>Confirmation Number: 8528</p> <p>First Named Applicant: TAE LEE</p> <p>Attorney Docket Number: AMKOR053G</p> <p>Art Unit: 2811</p> <p>Search string: (6348726 or 6355502 or 6369447 or 6369454 or 6373127 or 6380048 or 6384472 or 6388336 or 6395578 or 6410979 or 6400004 or 6414385 or 6420779 or 6429508 or 6437429 or 6444499 or 6448633 or 6452279 or 6459148 or 6464121 or 6476469 or 6476474 or 6482680 or 6498099 or 6498392 or 6507096 or 6507120 or 6534849 or 6545332 or 6545345 or 6559525 or 6566168 or 6583503 or 6667546),pn.</p> <p>US Patent Documents</p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td><input checked="" type="checkbox"/></td><td>1</td><td>6348726</td><td>2002-02-19</td><td>Bayan et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>2</td><td>6355502</td><td>2002-03-12</td><td>Kang et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>3</td><td>6369447</td><td>2002-04-09</td><td>Mori</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>4</td><td>6369454</td><td>2002-04-09</td><td>Chung</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>5</td><td>6373127</td><td>2002-04-16</td><td>Baudouin et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>6</td><td>6380048</td><td>2002-04-30</td><td>Boon et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>7</td><td>6384472</td><td>2002-05-07</td><td>Huang</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>8</td><td>6388336</td><td>2002-05-14</td><td>Venkateshwaran et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>9</td><td>6395578</td><td>2002-05-28</td><td>Shin et al.</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>10</td><td>6410979</td><td>2002-06-02</td><td>Abe</td><td></td><td></td><td></td></tr><tr><td><input type="checkbox"/></td><td>11</td><td>6400004</td><td>2002-06-04</td><td>Fan et al.</td><td></td><td></td><td></td></tr><tr><td><input checked="" type="checkbox"/></td><td>12</td><td>6414385</td><td>2002-07-02</td><td>Huang et al.</td><td></td><td></td><td></td></tr></tbody></table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	<input checked="" type="checkbox"/>	1	6348726	2002-02-19	Bayan et al.				<input type="checkbox"/>	2	6355502	2002-03-12	Kang et al.				<input type="checkbox"/>	3	6369447	2002-04-09	Mori				<input type="checkbox"/>	4	6369454	2002-04-09	Chung				<input type="checkbox"/>	5	6373127	2002-04-16	Baudouin et al.				<input type="checkbox"/>	6	6380048	2002-04-30	Boon et al.				<input type="checkbox"/>	7	6384472	2002-05-07	Huang				<input type="checkbox"/>	8	6388336	2002-05-14	Venkateshwaran et al.				<input type="checkbox"/>	9	6395578	2002-05-28	Shin et al.				<input type="checkbox"/>	10	6410979	2002-06-02	Abe				<input type="checkbox"/>	11	6400004	2002-06-04	Fan et al.				<input checked="" type="checkbox"/>	12	6414385	2002-07-02	Huang et al.			
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